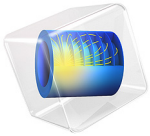

Thermal Expansion in a MEMS Device

Introduction

The purpose of this model is to exemplify the use of the Material Library in COMSOL Multiphysics. This library contains more than 20,000 property functions for over 2600 materials. The larger part of these properties are mechanical and thermal properties for solid materials given as functions of temperature. You need the Material Library to build the model.

The example also shows how to set up a model of thermal expansion when the structure is constrained.

Note: This model requires the Material Library.

Thermal expansion is a common method used in the microscale to displace a part of a component, for example in an actuator.

Model Definition

The figure below shows the model geometry:

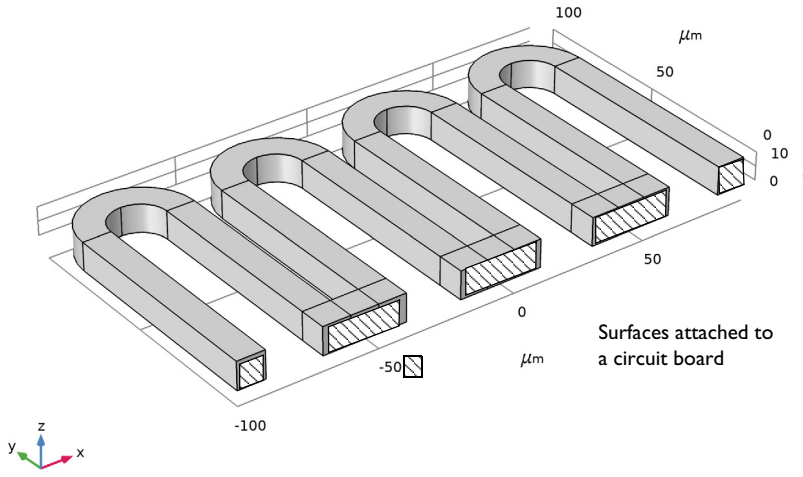

Figure 1: Geometry of the device.

The model consists of two sets of physics:

- A thermal balance with a heat source in the device, originating from Joule heating (ohmic heating). Air cooling is applied on the boundaries except at the position where the device is attached to a circuit board, where a thermal insulation condition is set.
- A force balance for the structural analysis with a volume load caused by thermal expansions. The device is fixed at the positions where it is attached to a circuit board (see Figure 1). The effect of possible thermal expansion for the circuit board is investigated.

The device is made of the copper-beryllium alloy UNS C17500, and the circuit board is made of FR4 material.

The thermal balance consists of a balance of flux at steady state. The heat flux is given by conduction only. The heat source is a constant heat source of $1 \cdot 10^8$ W/m^3. The air cooling at the boundaries is expressed using a constant heat transfer coefficient of 10 W/m^2 and an ambient temperature of 298 K.

The expression for thermal expansion requires a strain reference temperature for the copper-beryllium alloy, which in this case is 298 K.

All other thermal and mechanical properties are obtained from the Material Library.

Results and Discussion

The following figure shows the temperature distribution in the device. The heat source increases the temperature to around 323.67 K from an ambient temperature of 298 K. The temperature varies less than 1/100 of a degree in the device.

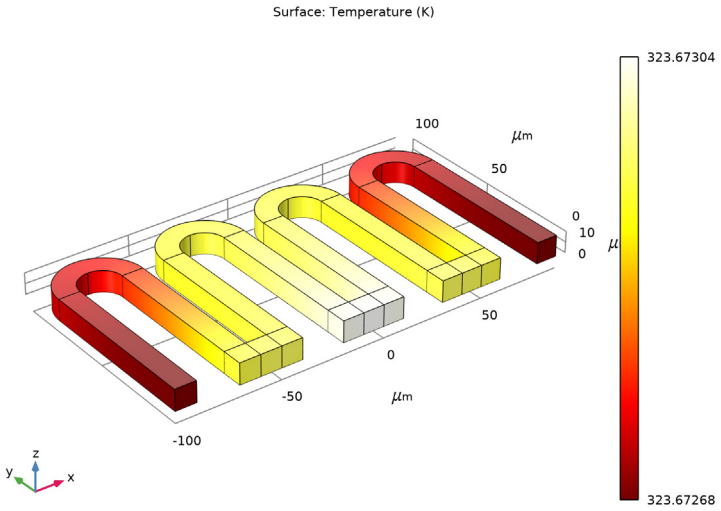

Figure 2: Temperature field in the device. The edges of the original geometry are shown in black. The deformed shape is exaggerated by a factor of 200.

The following figures show the stress field in the deformed device with fully constrained attachment boundaries (Figure 3), and with the expansion effect taken into account for the circuit board (Figure 4). The latter case leads to certain relaxation of the constraint applied to the device boundaries attached to the board. The resulting maximum von Mises stress becomes less by an order of magnitude. The stress is well within the elastic region for the material.

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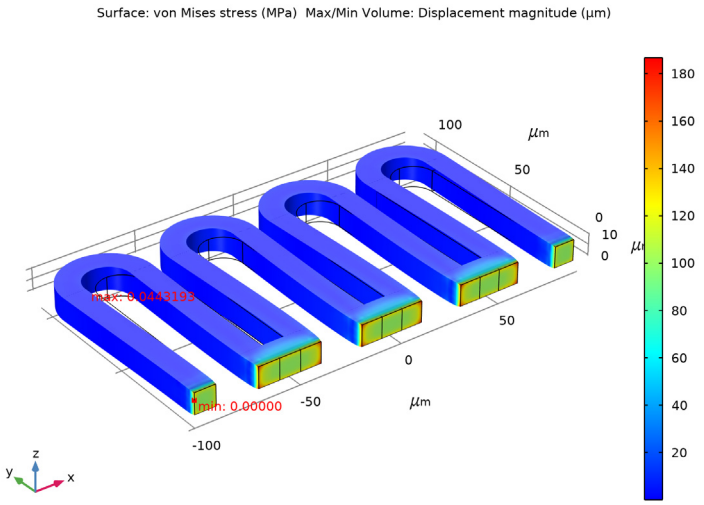


Figure 3: The von Mises stress in the deformed structure with fully constrained attachment boundaries. The edges of the original geometry are shown in black. The deformed shape is exaggerated by a factor of 200.

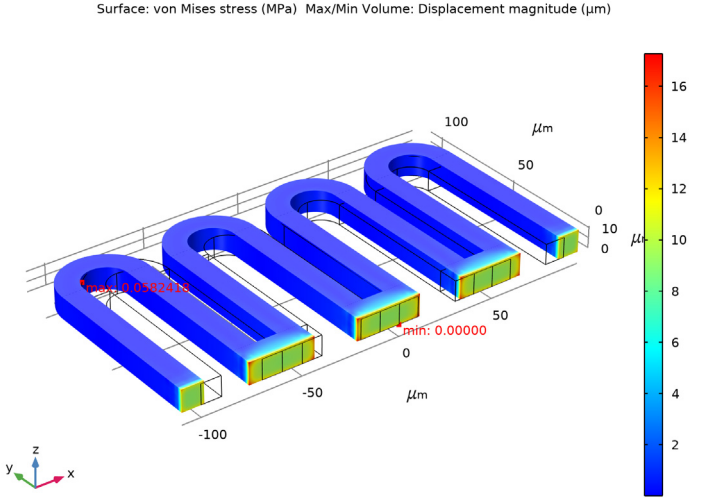


Figure 4: The von Mises stress in the deformed structure when the circuit board thermal expansion effect is modeled. The deformed shape is exaggerated by a factor of 200.

Application Library path: `Structural_Mechanics_Module/Thermal-Structure_Interaction/thermal_expansion`

Modeling Instructions

From the **File** menu, choose **New**.

NEW

In the **New** window, click **Model Wizard**.

MODEL WIZARD

1 In the **Model Wizard** window, click **3D**.

2 In the **Select Physics** tree, select **Structural Mechanics>Thermal-Structure Interaction> Thermal Stress, Solid**.

3 Click **Add**.

4 Click **Study**.

5 In the **Select Study** tree, select **General Studies>Stationary**.

6 Click **Done**.

GEOMETRY 1

1 In the **Model Builder** window, under **Component 1 (comp1)** click **Geometry 1**.

2 In the **Settings** window for **Geometry**, locate the **Units** section.

3 From the **Length unit** list, choose **µm**.

Work Plane 1 (wp1)

1 In the **Geometry** toolbar, click **Work Plane**.

2 In the **Settings** window for **Work Plane**, click **Show Work Plane**.

Work Plane 1 (wp1)>Plane Geometry

In the **Model Builder** window, click **Plane Geometry**.

Work Plane 1 (wp1)>Rectangle 1 (r1)

1 In the **Work Plane** toolbar, click **Rectangle**.

2 In the **Settings** window for **Rectangle**, locate the **Size and Shape** section.

3 In the **Width** text field, type 10.

4 In the **Height** text field, type 80.

5 Locate the **Position** section. In the **xw** text field, type -100.

6 In the **Work Plane** toolbar, click **Build All**.

Work Plane 1 (wp1)>Copy 1 (copy1)

1 In the **Work Plane** toolbar, click **Transforms** and choose **Copy**.

2 Select the object **r1** only.

3 In the **Settings** window for **Copy**, locate the **Displacement** section.

4 In the **xw** text field, type 30.

5 In the **Work Plane** toolbar, click **Build All**.

Work Plane 1 (wp1)>Circle 1 (c1)

1 In the **Work Plane** toolbar, click **Circle**.

2 In the **Settings** window for **Circle**, locate the **Size and Shape** section.

3 In the **Radius** text field, type 10.

4 Locate the **Position** section. In the **xw** text field, type -80.

5 In the **yw** text field, type 80.

6 In the **Work Plane** toolbar, click **Build All**.

Work Plane 1 (wp1)>Circle 2 (c2)

1 In the **Work Plane** toolbar, click **Circle**.

2 In the **Settings** window for **Circle**, locate the **Size and Shape** section.

3 In the **Radius** text field, type 20.

4 Locate the **Position** section. In the **xw** text field, type -80.

5 In the **yw** text field, type 80.

6 In the **Work Plane** toolbar, click **Build All**.

Work Plane 1 (wp1)>Rectangle 2 (r2)

1 In the **Work Plane** toolbar, click **Rectangle**.

2 In the **Settings** window for **Rectangle**, locate the **Size and Shape** section.

3 In the **Width** text field, type 40.

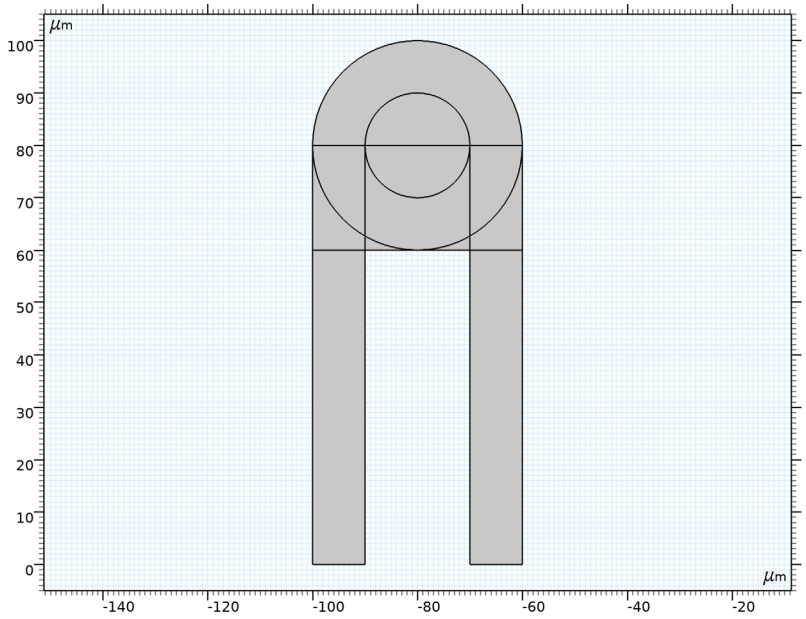
4 In the **Height** text field, type 20.

5 Locate the **Position** section. In the **xw** text field, type -100.

6 In the **yw** text field, type 60.

7 In the **Work Plane** toolbar, click **Build All**.

8 Click the **Zoom Extents** button in the **Graphics** toolbar.



Work Plane 1 (wp1)>Difference 1 (dif1)

1 In the **Work Plane** toolbar, click **Booleans and Partitions** and choose **Difference**.

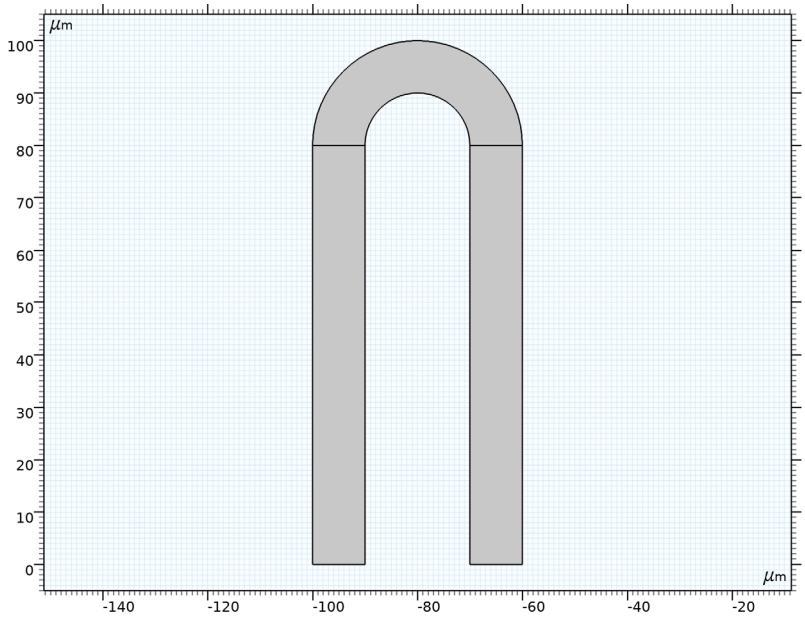
2 Select the object **c2** only.

3 In the **Settings** window for **Difference**, locate the **Difference** section.

4 Find the **Objects to subtract** subsection. Select the **Activate Selection** toggle button.

5 Select the objects **c1** and **r2** only.

6 In the **Work Plane** toolbar, click **Build All**.



Work Plane 1 (wp1)>Array 1 (arr1)

1 In the **Work Plane** toolbar, click **Transforms** and choose **Array**.

2 Click in the **Graphics** window and then press Ctrl+A to select all objects.

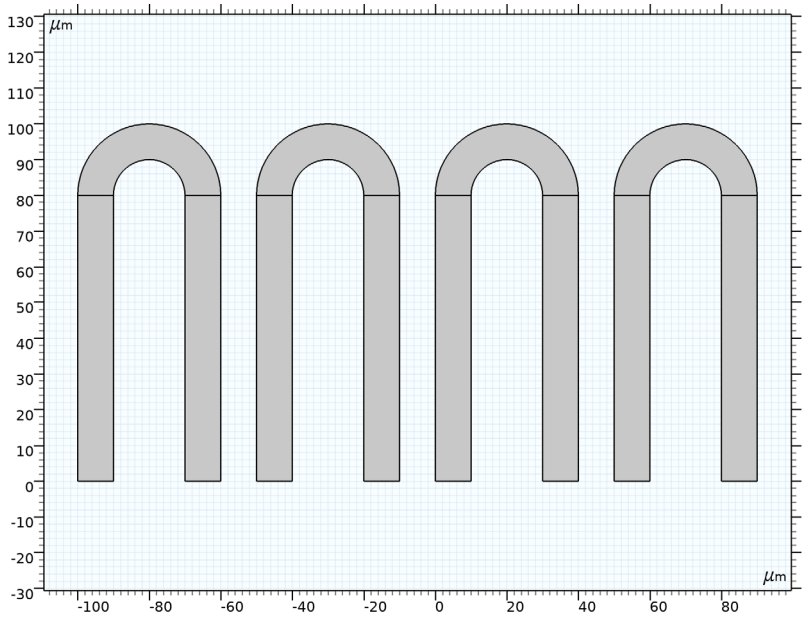
3 In the **Settings** window for **Array**, locate the **Size** section.

4 In the **xw size** text field, type 4.

5 Locate the **Displacement** section. In the **xw** text field, type 50.

6 In the **Work Plane** toolbar, click **Build All**.

7 Click the **Zoom Extents** button in the **Graphics** toolbar.



Work Plane 1 (wp1)>Rectangle 3 (r3)

1 In the **Work Plane** toolbar, click **Rectangle**.

2 In the **Settings** window for **Rectangle**, locate the **Size and Shape** section.

3 In the **Width** text field, type 30.

4 In the **Height** text field, type 10.

5 Locate the **Position** section. In the **xw** text field, type -70.

6 In the **Work Plane** toolbar, click **Build All**.

Work Plane 1 (wp1)>Array 2 (arr2)

1 In the **Work Plane** toolbar, click **Transforms** and choose **Array**.

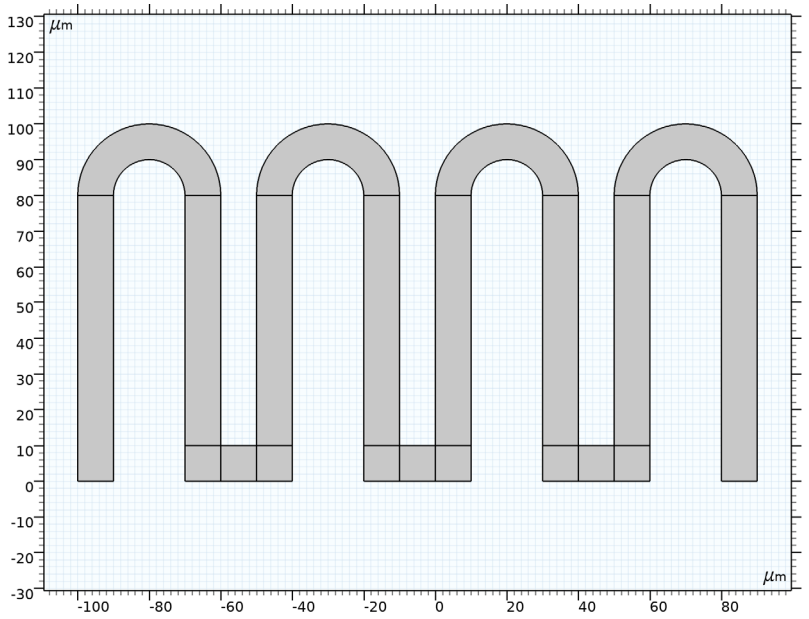
2 Select the object **r3** only.

3 In the **Settings** window for **Array**, locate the **Size** section.

4 In the **xw size** text field, type 3.

5 Locate the **Displacement** section. In the **xw** text field, type 50.

6 In the **Work Plane** toolbar, click **Build All**.



Extrude 1 (ext1)

1 In the **Model Builder** window, under **Component 1 (comp1)>Geometry 1** right-click **Work Plane 1 (wp1)** and choose **Extrude**.

2 In the **Settings** window for **Extrude**, locate the **Distances** section.

3 In the table, enter the following settings:

Distances (μm)
10

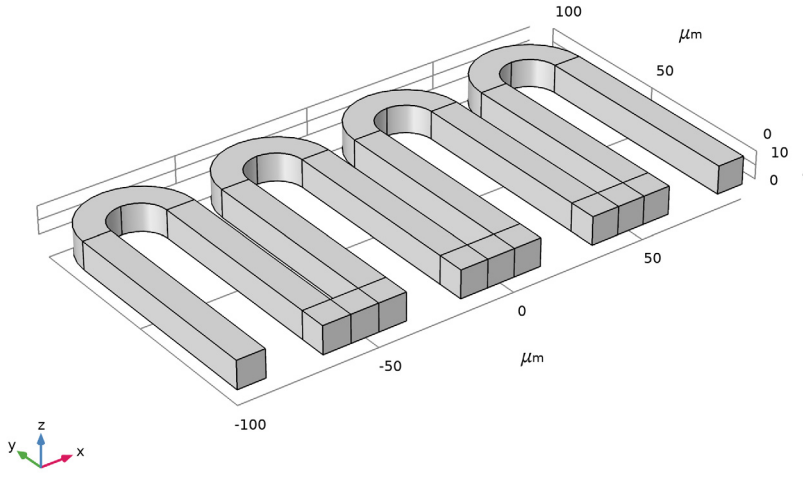
4 Click **Build All Objects**.

Form Union (fin)

1 In the **Model Builder** window, click **Form Union (fin)**.

2 In the **Settings** window for **Form Union/Assembly**, click **Build Selected**.

3 Click the **Zoom Extents** button in the **Graphics** toolbar.



Next, create selections for use when defining the boundary conditions.

DEFINITIONS

Fixed

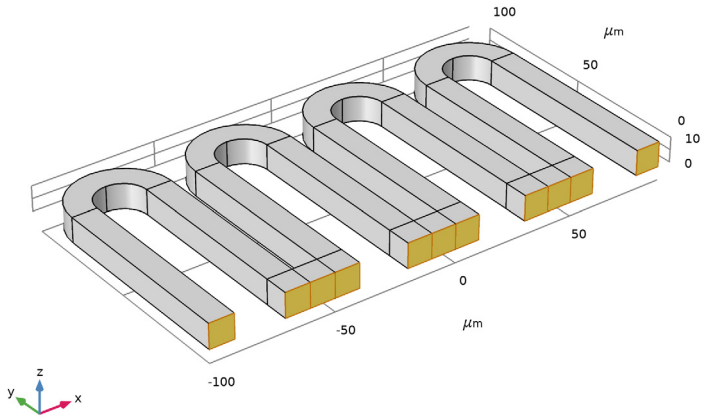
1 In the **Definitions** toolbar, click **Box**.

2 In the **Settings** window for **Box**, type `Fixed` in the **Label** text field.

3 Locate the **Geometric Entity Level** section. From the **Level** list, choose **Boundary**.

4 Locate the **Box Limits** section. In the **y maximum** text field, type `1[um]`.

5 Locate the **Output Entities** section. From the **Include entity if** list, choose **Entity inside box**.



Heat Flux

1 In the **Definitions** toolbar, click **Complement**.

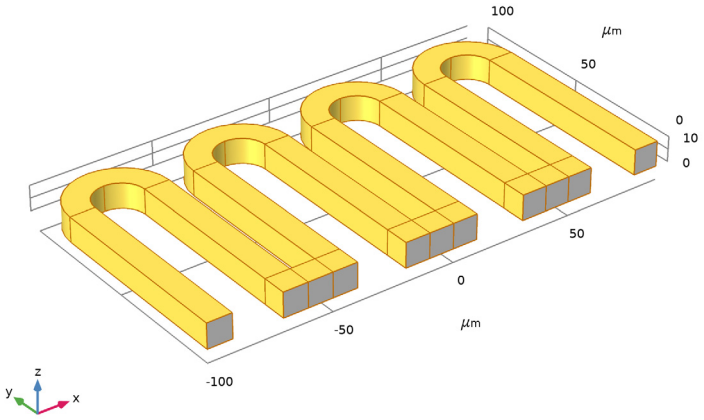
2 In the **Settings** window for **Complement**, type `Heat Flux` in the **Label** text field.

3 Locate the **Geometric Entity Level** section. From the **Level** list, choose **Boundary**.

4 Locate the **Input Entities** section. Under **Selections to invert**, click **Add**.

5 In the **Add** dialog box, select **Fixed** in the **Selections to invert** list.

6 Click **OK**.



Top

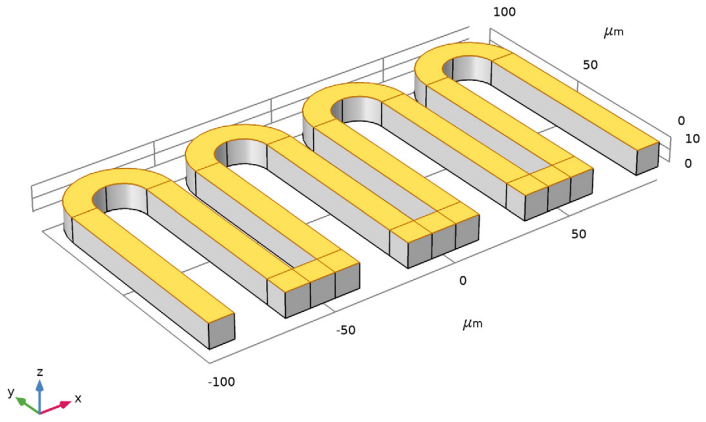
1 In the **Definitions** toolbar, click **Box**.

2 In the **Settings** window for **Box**, type `Top` in the **Label** text field.

3 Locate the **Geometric Entity Level** section. From the **Level** list, choose **Boundary**.

4 Locate the **Box Limits** section. In the **z minimum** text field, type `1[um]`.

5 Locate the **Output Entities** section. From the **Include entity if** list, choose **Entity inside box**.



ADD MATERIAL

1 In the **Home** toolbar, click **Add Material** to open the **Add Material** window.

2 Go to the **Add Material** window.

3 In the tree, select **Material Library>Copper Alloys>UNS C17500>UNS C17500 [solid]**.

4 Click **Add to Component** in the window toolbar.

5 In the **Home** toolbar, click **Add Material** to close the **Add Material** window.

MATERIALS

UNS C17500 [solid] (mat1)

1 In the **Settings** window for **Material**, locate the **Material Contents** section.

2 In the table, enter the following settings:

Property	Variable	Value	Unit	Property group
Poisson's ratio	nu	0.34	1	Young's modulus and Poisson's ratio

MULTIPHYSICS

Thermal Expansion 1 (te1)

1 In the **Model Builder** window, under **Component 1 (comp1)>Multiphysics** click **Thermal Expansion 1 (te1)**.

2 In the **Settings** window for **Thermal Expansion**, locate the **Model Input** section.

3 Click **Go to Source**.

GLOBAL DEFINITIONS

Default Model Inputs

1 In the **Model Builder** window, under **Global Definitions** click **Default Model Inputs**.

2 In the **Settings** window for **Default Model Inputs**, locate the **Browse Model Inputs** section.

3 Find the **Expression for remaining selection** subsection. In the **Volume reference temperature** text field, type `298[K]`.

SOLID MECHANICS (SOLID)

Fixed Constraint 1

1 In the **Model Builder** window, under **Component 1 (comp1)** right-click **Solid Mechanics (solid)** and choose **Fixed Constraint**.

2 In the **Settings** window for **Fixed Constraint**, locate the **Boundary Selection** section.

3 From the **Selection** list, choose **Fixed**.

HEAT TRANSFER IN SOLIDS (HT)

In the **Model Builder** window, under **Component 1 (comp1)** click **Heat Transfer in Solids (ht)**.

Heat Source 1

1 In the **Physics** toolbar, click **Domains** and choose **Heat Source**.

2 In the **Settings** window for **Heat Source**, locate the **Domain Selection** section.

3 From the **Selection** list, choose **All domains**.

4 Locate the **Heat Source** section. In the Q_0 text field, type `1e8`.

Heat Flux 1

1 In the **Physics** toolbar, click **Boundaries** and choose **Heat Flux**.

2 In the **Settings** window for **Heat Flux**, locate the **Boundary Selection** section.

3 From the **Selection** list, choose **Heat Flux**.

4 Locate the **Heat Flux** section. Click the **Convective heat flux** button.

5 In the h text field, type 10.

6 In the T_{ext} text field, type 298.

MESH 1

Mapped 1

1 In the **Mesh** toolbar, click **Boundary** and choose **Mapped**.

2 In the **Settings** window for **Mapped**, locate the **Boundary Selection** section.

3 From the **Selection** list, choose **Top**.

Size 1

1 Right-click **Mapped 1** and choose **Size**.

2 In the **Settings** window for **Size**, locate the **Element Size** section.

3 From the **Predefined** list, choose **Extremely fine**.

4 Click **Build All**.

Swept 1

In the **Mesh** toolbar, click **Swept**.

Distribution 1

1 Right-click **Swept 1** and choose **Distribution**.

2 In the **Settings** window for **Distribution**, locate the **Distribution** section.

3 In the **Number of elements** text field, type 3.

4 Click **Build All**.

5 Click the **Zoom Extents** button in the **Graphics** toolbar.

FIXED BOARD

1 In the **Model Builder** window, click **Study 1**.

2 In the **Settings** window for **Study**, type `Fixed Board` in the **Label** text field.

3 In the **Home** toolbar, click **Compute**.

RESULTS

Stress (solid)

The first default plot shows the von Mises stress in the deformed material. Add markers to show the minimum and maximum displacement, and adjust the deformation scaling to reproduce the plot shown in Figure 3.

Surface 1

1 In the **Model Builder** window, expand the **Stress (solid)** node, then click **Surface 1**.

2 In the **Settings** window for **Surface**, locate the **Expression** section.

3 From the **Unit** list, choose **MPa**.

Stress (solid)

In the **Model Builder** window, click **Stress (solid)**.

Max/Min Volume 1

1 In the **Stress (solid)** toolbar, click **More Plots** and choose **Max/Min Volume**.

2 In the **Settings** window for **Max/Min Volume**, locate the **Coloring and Style** section.

3 From the **Color** list, choose **Red**.

Deformation

1 In the **Model Builder** window, expand the **Results>Stress (solid)>Surface 1** node, then click **Deformation**.

2 In the **Settings** window for **Deformation**, locate the **Scale** section.

3 Select the **Scale factor** check box.

4 In the associated text field, type 200.

5 In the **Stress (solid)** toolbar, click **Plot**.

6 Click the **Go to Default View** button in the **Graphics** toolbar.

Temperature (ht)

The second default plots shows the temperature field that should be similar to that displayed in Figure 2.

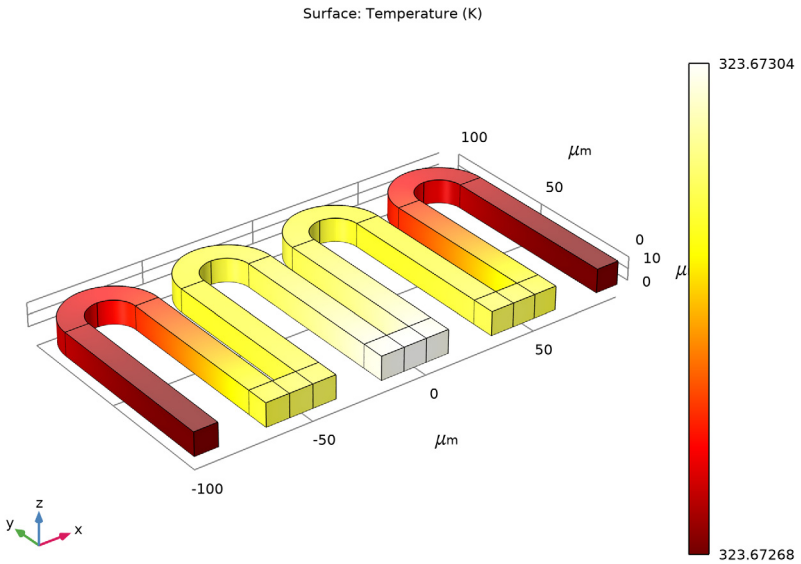
1 In the **Model Builder** window, click **Temperature (ht)**.

2 In the **Settings** window for **3D Plot Group**, click to expand the **Number Format** section.

3 Select the **Manual color legend settings** check box.

4 In the **Precision** text field, type 6.

5 In the **Temperature (ht)** toolbar, click **Plot**.



Next include the thermal expansion effect for the circuit board. Add another material to represent it.

ADD MATERIAL

1 In the **Home** toolbar, click **Add Material** to open the **Add Material** window.

2 Go to the **Add Material** window.

3 In the tree, select **Built-in>FR4 (Circuit Board)**.

4 Click **Add to Component 1 (comp1)**.

5 In the **Home** toolbar, click **Add Material** to close the **Add Material** window.

MATERIALS

FR4 (Circuit Board) (mat2)

1 In the **Settings** window for **Material**, locate the **Geometric Entity Selection** section.

2 From the **Geometric entity level** list, choose **Boundary**.

3 From the **Selection** list, choose **Fixed**.

SOLID MECHANICS (SOLID)

Fixed Constraint 1

In the **Model Builder** window, under **Component 1 (comp1)>Solid Mechanics (solid)** click **Fixed Constraint 1**.

Thermal Expansion 1

1 In the **Physics** toolbar, click **Attributes** and choose **Thermal Expansion**.

2 In the **Settings** window for **Thermal Expansion**, locate the **Boundary Selection** section.

3 From the **Selection** list, choose **Fixed**.

4 Locate the **Thermal Expansion Properties** section. In the T text field, type `solid.T`.

5 In the T_{ref} text field, type `298[K]`.

Add a second study for computation with board thermal expansion.

ADD STUDY

1 In the **Home** toolbar, click **Add Study** to open the **Add Study** window.

2 Go to the **Add Study** window.

3 Find the **Studies** subsection. In the **Select Study** tree, select **General Studies>Stationary**.

4 Click **Add Study** in the window toolbar.

5 In the **Home** toolbar, click **Add Study** to close the **Add Study** window.

EXPANDED BOARD

1 In the **Model Builder** window, click **Study 2**.

2 In the **Settings** window for **Study**, type `Expanded Board` in the **Label** text field.

3 Locate the **Study Settings** section. Clear the **Generate default plots** check box.

4 In the **Home** toolbar, click **Compute**.

Group and duplicate the existing plots, then set them to the newly created dataset.

RESULTS

Isothermal Contours (ht), Stress (solid), Temperature (ht)

1 In the **Model Builder** window, under **Results**, Ctrl-click to select **Stress (solid)**, **Temperature (ht)**, and **Isothermal Contours (ht)**.

2 Right-click and choose **Group**.

Fixed Board

In the **Settings** window for **Group**, type `Fixed Board` in the **Label** text field.

Expanded Board

1 Right-click **Fixed Board** and choose **Duplicate**.

2 In the **Model Builder** window, click **Fixed Board 1**.

3 In the **Settings** window for **Group**, type `Expanded Board` in the **Label** text field.

Stress (solid) 1

1 In the **Model Builder** window, click **Stress (solid) 1**.

2 In the **Settings** window for **3D Plot Group**, locate the **Data** section.

3 From the **Dataset** list, choose **Expanded Board/Solution 2 (sol2)**.

4 In the **Stress (solid) 1** toolbar, click **Plot**.

The computed stress field and deformation should be similar to that shown in Figure 4.

Temperature (ht) 1

1 In the **Model Builder** window, click **Temperature (ht) 1**.

2 In the **Settings** window for **3D Plot Group**, locate the **Data** section.

3 From the **Dataset** list, choose **Expanded Board/Solution 2 (sol2)**.

Isothermal Contours (ht) 1

1 In the **Model Builder** window, click **Isothermal Contours (ht) 1**.

2 In the **Settings** window for **3D Plot Group**, locate the **Data** section.

3 From the **Dataset** list, choose **Expanded Board/Solution 2 (sol2)**.

Finally, disable the circuit board thermal expansion in the first study, so that you can compute the fixed configuration again.

FIXED BOARD

Step 1: Stationary

1 In the **Model Builder** window, expand the **Fixed Board** node, then click **Step 1: Stationary**.

2 In the **Settings** window for **Stationary**, locate the **Physics and Variables Selection** section.

3 Select the **Modify model configuration for study step** check box.

4 In the **Physics and variables selection** tree, select **Component 1 (comp1)>Solid Mechanics (solid)>Fixed Constraint 1>Thermal Expansion 1**.

5 Click **Disable**.